



SURFACE MOUNT SWITCHING DIODE

Features

- Fast Switching Speed •
- Ultra-Small Leadless Surface Mount Package (1.0*0.6mm)
- Ultra-Low Profile Package (0.4mm)
- Low Forward Voltage
- Fast Reverse Recovery
- Low Capacitance
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

- Case: X2-DFN1006-2 •
- Case Material: Molded Plastic, "Green" Molding Compound. UL • Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0009 grams (approximate)

X2-DFN1006-2



Bottom View

Ordering Information (Note 3)

Part Number	Case	Packaging
BAS116LPH4-7B	X2-DFN1006-2	10,000/Tape & Reel

Notes:

1. No purposefully added lead. 2.

Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com. 3.

For packaging details, go to our website at http://www.diodes.com.

Marking Information

5K

5K = Product Type Marking Code Bar Denotes Cathode Side



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	85	V
RMS Reverse Voltage		V _{R(RMS)}	60	V
Forward Continuous Current (Note 4)		I _{FM}	215	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I _{FSM}	4.0 1.0 0.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	PD	300	mW
Thermal Resistance Junction to Ambient Air (Note 4)	R _{θJA}	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

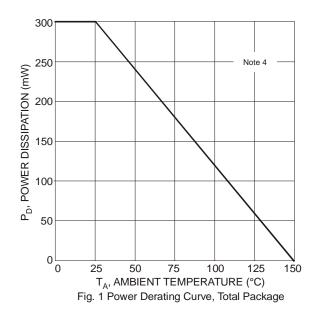
Electrical Characteristics @T_A = 25°C unless otherwise specified

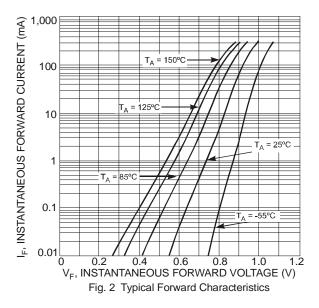
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	85	_	_	V	I _R = 100μA
Forward Voltage	V _F			0.9 1.0 1.1 1.25	V	$I_{F} = 1.0mA$ $I_{F} = 10mA$ $I_{F} = 50mA$ $I_{F} = 150mA$
Leakage Current (Note 5)	I _R		_	5.0 80	nA nA	V _R = 75V V _R = 75V, T _J = 150°C
Total Capacitance	CT		1.5	_	pF	$V_{R} = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}		_	3.0	μs	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:

Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com. 4. 5.

Short duration pulse test used to minimize self-heating effect.

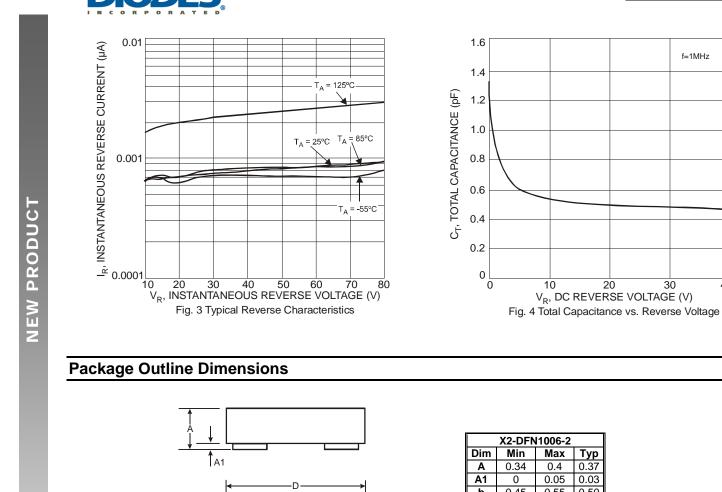


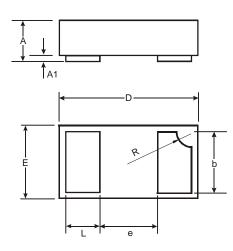




f=1MHz

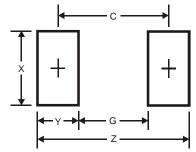
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	X2-DFN1006-2				
Dim	Min	Max	Тур		
Α	0.34	0.4	0.37		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
E	0.55	0.675	0.60		
Ε	_	_	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout



Value (in mm)
1.1
0.3
0.7
0.4
0.7

BAS116LPH4 Document number: DS35242 Rev. 5 - 2



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